

# VIEW Benchmark™ 450

A high value, high accuracy dimensional metrology system



## BENCHMARK

Ideal for measuring large footprint parts such as Stencils, PCBs or nested groups of parts

## Featuring:

450 x 450 x 200 mm (18 x 18 x 8 in.) measuring range

 $E_2$  (XY plane) = (2.5 + 5L/1000)  $\mu$ m

Sub-micron scale resolution

High-precision dual magnification optical system

Optional Programmable Multi-Color Ring Light (PRL)

Optional through-the-lens (TTL) laser with autofocus and scanning capabilities

Advanced image processing for high speed, accuracy and robustness

Subpixel accuracy of 1/10 to 1/50 pixel

Choice of powerful metrology software and data analysis tools

MTBF 8,000 hours



Photo Description: VIEW Benchmark 450
The product photo above displays the Benchmark 450 model with VMS metrology software, and optional integrated workstation. Additional options are listed in the technical

specifications and are not included in this photo.

## BENCHMARK

The VIEW Benchmark™ 450 delivers the performance and reliability you expect from VIEW Micro-Metrology in a large travel, non contact metrology system. It includes a large, 450 x 450 mm stage suitable for large footprint parts or nested groups of smaller parts. Advanced optics, illumination, and image processing make the Benchmark 450 a world-class metrology system.

Benchmark 450 is equally at home in the QA lab performing first article inspection or on the production floor providing precision measurements for process control

Available optional software packages increase system versatility:

- CAD import (DXF/IGES) Software
- Form fitting and analysis Software
- Off-line Programming Software
- QC-Calc™ Statistical Process Control (SPC) Real-time analysis and reporting software
- Elements™ CAD To Measure metrology software

## Advanced metrology for leading technologies

Applications for Benchmark include:

#### SMT and Electronic Components

- PCBs and Stencils
- SMT component placement
- Solder paste/Epoxy glue dot
- Chip carriers and trays
- Inkjet printer cartridges
- · Lead frames, wire bonds, flex circuits, connectors
- Fiber optic components and MEMs

#### **Data Storage**

- Wafer carriers and row bar pallets
- Slider and Head Gimble Assemblies (HGA)
- Suspensions

### Precision plastic molded and machined parts

- Dies and tooling
- Medical devices
- Fuel injection components
- Watch components

Technical Specifications - VIEW Benchmark™ 450

450 x 450 x 200 mm (18 x 18 x 8 in.) Measuring Range

○ 0.1 µm (0.000004") Resolution

Stage Drive System DC servo motor control

XY: 150 mm/sec; Z: 100 mm/sec. Stage Drive Velocity Stage Error Mapping Non-linear 2D error corrections in X-Y plane

O 65 kg (140 lbs) maximum load **Load Capacity** 

Dual magnification, fixed lens optical system with 1X and 4X internal **Optical System** magnifications

Objective Magnification 0.8x/3.2x 2.5x/10x 1x/4x 5x/20x 10x/40x 25x/100x  $\bigcirc$ **Working Distance** 84 mm 34 mm 32 mm 33 mm 30 mm 13 mm

Field of View (mm) Low 8.3 x 6.2 6.8 x 5.1 2.7 x 2.0 1.3 x 1.03  $0.6 \times 0.5$ 0.27 x 0.20

High ( 1.9 x 1.4 0.06 x 0.05 1.5 x 1.2 0.64 x 0.48 0.32 x 0.24 0.15 x 0.11

Standard

Optional

 Ronchi Grid Projection **Optical Accessories** 

Illumination O Programmable LED Illumination system for stage backlight and coaxial surface light

 Multi-color (red, blue, green, and composed white) LED Illumination Programmable Ring Light (PRL)

■ VectorLight<sup>™</sup> programmable ringlight with white LEDs

Dual, digital, 1.4 megapixel monochrome cameras; 4:1 ratio Cameras

● Frame integration; 10:1 to 50:1 subpixeling Image Processing CiC - Continuous Image Capture integrated with stage motion for

on-the-fly high speed measurement

 Through-the-lens (TTL) laser autofocus and scanning sensor **Sensor Options** SpectraProbe™ high resolution chromatic sensor

Controller

Dedicated system controller with embedded Intel® 2.66 Ghz Quad CPU Processor and Windows® operating system

**Operator Workstation**  Stand-alone Anthro Cart Operator workstation; 90 x 90 x 128 cm; 40 kg Integrated adjustable sit / stand workstation arm, with independent height

adjustment for monitor and keyboard.

**Display Monitors** Single 20" LCD flat panel monitor, joystick, keyboard, and mouse

Dual 20" LCD flat panel monitors, joystick, keyboard, and mouse

**Metrology Software** VIEW Metrology Software (VMS)

■ Elements<sup>™</sup> CAD to Measure metrology software

VMS Off-Line Workstation Software

**Mechanical Options** Certified calibration standards and accessories

> Fixture kits Rotary Indexers

MTBF ≥ 8,000 hours

115/230 VAC, 50/60 Hz, 700 W **Power Supply** 

18-22°C, (65-71°F) 30-80% humidity (non-condensing), Rated Environment vibration < 0.0015g below 15Hz

System Dimensions (W x D x H) - 1380 x 1117 x 1700 mm (39 x 44 x 67 in.)

Weight Crated: 750 kg (1,650 lbs) Uncrated: 610 kg (1,345 lbs)

**Measuring Accuracy**  $\bigcirc$  E<sub>2</sub> (XY plane) = (2.5 + 5L/1000)  $\mu$ m<sup>1,2,3,4</sup>

at 20°C (68°F)  $\bigcirc$  E<sub>1</sub> (Z-axis) = (2.0 + 8L/1000)  $\mu$ m<sup>1,2,5</sup>

 $\bullet$  E<sub>1</sub> (Z-axis) = (2.0 + 5L/1000)  $\mu$ m (with optional laser and 5x lens)

Where L = measuring length in mm. All specifications apply to a thermally stable

machine and a certified artifact at 20°C.

and a certified artifact at 20°C.

1. Maximum rate of temperature change: 1° C / Hour.

2. Maximum vertical temperature gradient: 1° C / Meter

3. At rated velocity with an evenly distributed load of SKG.

4. X.Y area accuracy artifact: OVI grid reticle or OVI linescale in the standard measuring plane.

Standard measuring plane is defined as within 25mm of the worktable surface.

5. Z axis accuracy artifact: QVI step gage, interferometer or master gage blocks.